



PP508-1

Through-hole PIN Photodiode/Right Angle Type

Features

| Package | Right angle type, Black Visible Radiation Cut Filter epoxy |
|-----------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product features | Outer Dimension 5 x 4.1 mm (Right Angle Type) High Photo Current : 5.5 µ A(V_R=5V,Ee=0.5mW/cm²) Wide Distribution Visible Radiation Cut Filter under 700nm No lead package RoHS compliant |
| Peak Sensitivity Wavelength | 950nm |
| Half Intensity Angle | $\theta x = 130 \text{ deg.}, \ \theta y = 150 \text{ deg.}$ |
| Die materials | Si |
| Soldering methods | TTW (Through The Wave) soldering and manual soldering XPlease refer to Soldering Conditions about soldering. |
| ESD | 2kV (HBM) |
| Packing | Bulk : 200pcs(MIN.) |

Recommended Applications

Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications



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Absolute Maximum Ratings

$(Ta=25^{\circ}C)$

| Item | Symbol | Absolute Maximum Ratings | Unit |
|-----------------------|------------------|--------------------------|------|
| Power Dissipation | P _d | 100 | mW |
| Reverse Voltage | V _R | 30 | V |
| Operating Temperature | T _{opr} | -30~+85 | C |
| Storage Temperature | T _{stg} | -30~+100 | C |

Electro-Optical Characteristics

(Ta=25°C)

| ltem | | Symbol | Characteristics | | Unit |
|--------------------------------|----------------------------------------------------------------|----------------|-----------------|------------------|------|
| item | Conditions | Symbol | Characteristics | | Umt |
| Photo Current | V _R =5V, Ee=0.5mW/cm ² ^{**1} | lp | TYP. | 5.5 | μA |
| Response Time | V _R =10V, R _L =1,000Ω | tr/tf | TYP. | 50 | ns |
| Capacity | V _R =10V, f=1MHz | CT | ТҮР. | 11 | pF |
| Dark Current | V _R =10V | I _D | Max. | 20 | nA |
| Peak Sensitivity Wavelength | V _R =0V | λρ | ТҮР. | 950 | nm |
| Sensitivity ^{*2} | $V_{R}=5V,$ $\lambda =950$ nm | S | ТҮР. | 0.64 | A/W |
| Spatial Half Width | V _R =5V | Δθ | TYP. | 130(θx) | deg. |
| Spatial Half Width | | | TYP. | 150(<i>θ</i> у) | |

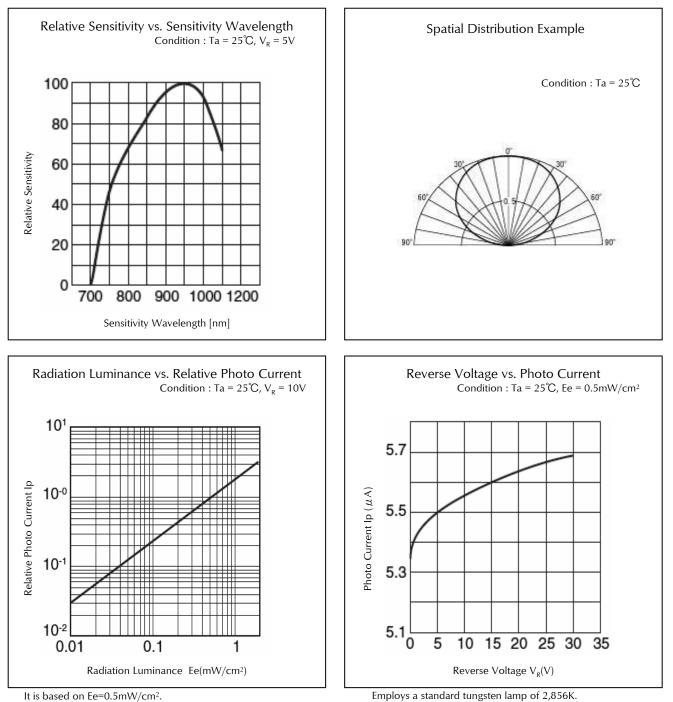
%1 Color temperature is 2,856K. Employs a standard tungsten lamp.

※2 By water clear package





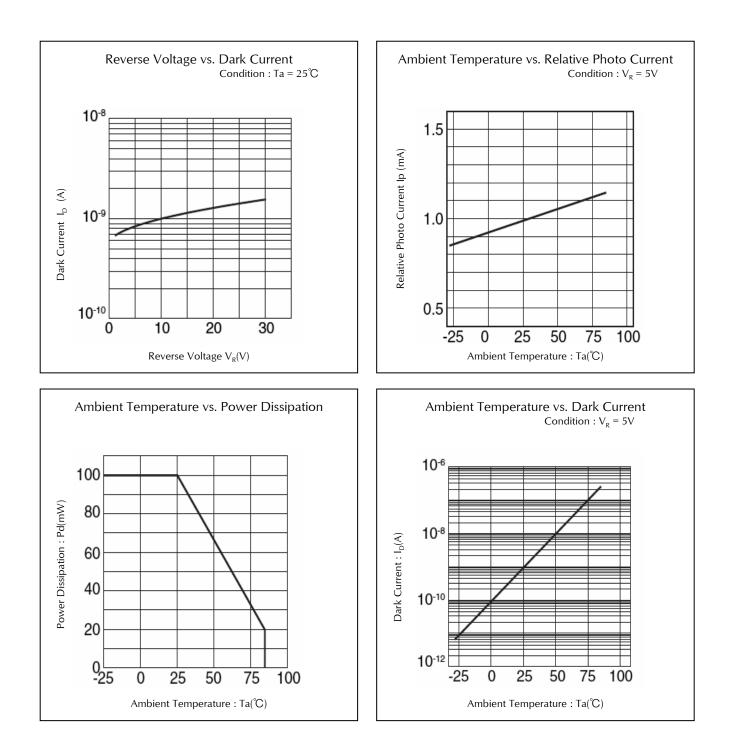
Technical Data



Employs a standard tungsten lamp of 2,856K.



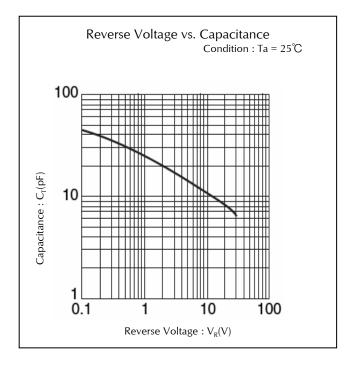
Technical Data







Technical Data

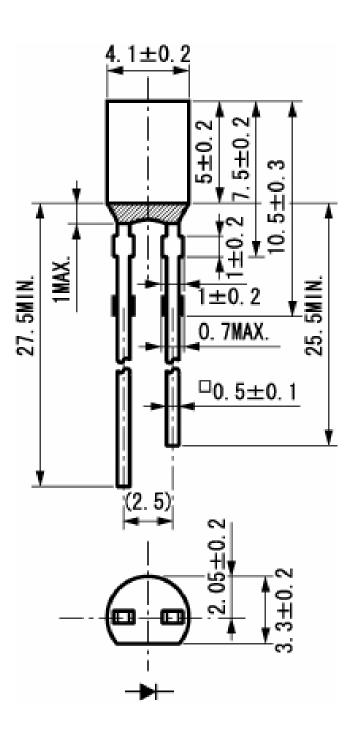




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Package Dimensions

(Unit: mm)







TTW (Through The Wave) soldering Conditions

| Pre-heating | 100 °C | (MAX.) Resin surface temperature |
|-------------------|-------------|----------------------------------|
| Solder Bath Temp. | 260 °C | (MAX.) |
| Dipping Time | 5 s | (MAX.) |
| Position | At least 3. | 0 mm away from resin body |

1) The dip soldering process shall be 2 times maximum.

 The product shall be cooled to normal temperature before the second dipping process.
 %The detail is described to LED and Photodetector handling precautions of home page: "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

| Iron tip temp. | 300 °C | (MAX.) (30 W Max.) | |
|------------------------------|--------------------------------------|--------------------|--|
| Soldering time and frequency | 3 s 1 time | (MAX.) (MAX.) | |
| Position | At least 3.0 mm away from resin body | | |

% The detail is described to LED and Photodetector handling precautions of home page: "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.





Through-hole PIN Photodiode/Right Angle Type

Reliability Testing Result

| Reliability Testing Result | Applicable Standard | Testing Conditions | Duration | Failure |
|----------------------------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------|
| Room Temp. Operating Life | EIAJ ED- 4701/100(101) | Ta = 25° C , Pd = Maxium Rated Power Dissipation | 1,000 h | 0/16 |
| Resistance to | EIAJ ED- | 260±5°C, 3mm from package base | 5sec | 0/16 |
| Soldering Heat | 4701/300(302) | Pb-free 265±5°C, 3mm from package base | 5sec | 0/16 |
| Temperature Cycling | EIAJ ED- 4701/100(105) | Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min) | 5 cycles | 0/16 |
| Wet High Temp. Storage Life | EIAJ ED- 4701/100(103) | $T_a = 60 \pm 2^{\circ}C$, RH = 90 ± 5% | 1,000 h | 0/16 |
| High Temp. Storage Life | EIAJ ED- 4701/200(201) | Ta = Maximum Rated Storage Temperature | 1 <i>,</i> 000 h | 0/16 |
| Low Temp. Storage Life | EIAJ ED- 4701/200(202) | Ta = Minimum Rated Storage Temperature | 1,000 h | 0/16 |
| Lead Tension | EIAJ ED- 4701/400(401) | 10N,1time (□0.4 and Flat Package : 5N) | 10sec | 0/16 |
| Vibration, Variable Frequency | EIAJ ED- 4701/400(403) | 98.1m/s ² (10G), 100 \sim 2KHz sweep for 20min., XYZ each direction | 2 h | 0/16 |

Failure Criteria

| ltems | Symbols | Conditions | Failure criteria |
|---------------------|---------|-------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| Photo Current | lp | EE Value of each product Irradiance of Photo Current V _R Value of each product Reverse Voltage of Photo Current | Testing Max. Value ≧Initial Value x 1.3 Testing Min. Value ≦ Initial Value x 0.7 |
| Dark Current | ID | VR Value of each product Reverse Voltage of Dark Current | Testing Max. Value ≧ Spec. Max. Value x 1.2 |
| Cosmetic Appearance | - | - | No notable, decoloration, deformation and cracking |



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